

FEATURES

- * Ideal for surface mount applications
- * Easy pick and place
- * Built-in strain relief
- * Low forward voltage drop

MECHANICAL DATA

- * Case: Molded plastic
- * Epoxy: UL 94V-0 rate flame retardant
- * Metallurgically bonded construction
- * Polarity: Color band denotes cathode end
- * Mounting position: Any

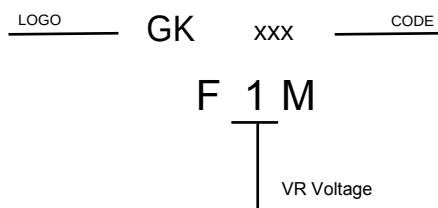


VOLTAGE RANGE

1000 Volts

CURRENT

1.0 Ampere



MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Rating 25°C ambient temperature unless otherwise specified.
Single phase half wave, 60Hz, resistive or inductive load.
For capacitive load, derate current by 20%.

TYPE NUMBER	SOD1F7	UNITS
Maximum Recurrent Peak Reverse Voltage	1000	V
Maximum RMS Voltage	700	V
Maximum DC Blocking Voltage	1000	V
Maximum Average Forward Rectified Current	1.0	A
Peak Forward Surge Current, 8.3 ms single half sine-wave superimposed on rated load (JEDEC method)	30	A
Maximum Instantaneous Forward Voltage at 1.0A	1.3	V
Maximum DC Reverse Current Ta=25°C	5.0	μA
at Rated DC Blocking Voltage Ta=100°C	100	μA
Maximum Reverse Recovery Time (Note 1)	500	nS
Typical Junction Capacitance (Note 2)	15	pF
Typical Thermal Resistance R JA (Note 3)	80	°C/W
Operating and Storage Temperature Range T _J , T _{STG}	-65 — +150	°C

NOTES:

1. Reverse Recovery Time test condition: IF=0.5A, IR=1.0A, IRR=0.25A
2. Measured at 1MHz and applied reverse voltage of 4.0V D.C.
3. Thermal Resistance from Junction to Ambient.

RATING AND CHARACTERISTIC CURVES

FIG.1-TYPICAL FORWARD CURRENT DERATING CURVE

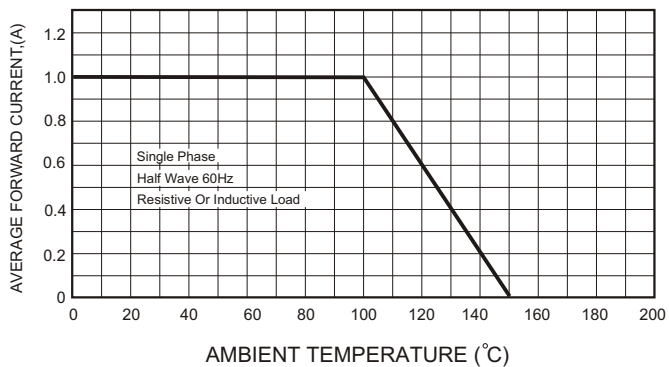


FIG.2-TYPICAL FORWARD CHARACTERISTICS

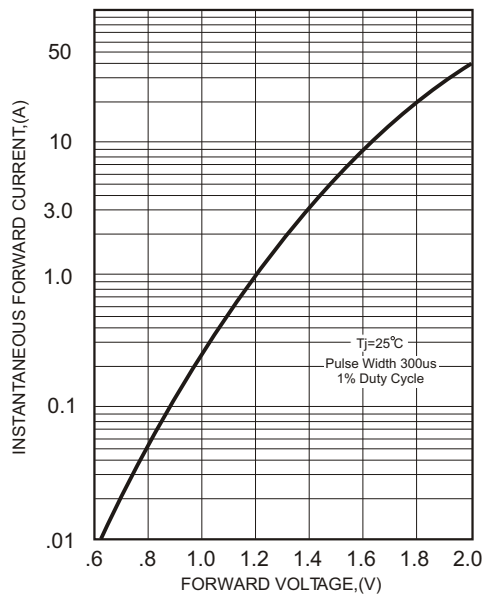
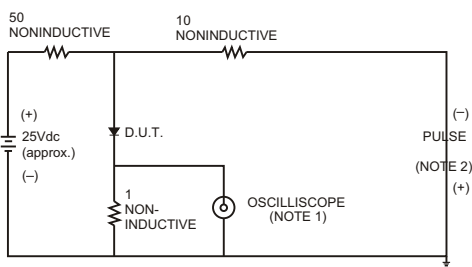


FIG.3- TEST CIRCUIT DIAGRAM AND REVERSE RECOVERY TIME CHARACTERISTICS



NOTES: 1. Rise Time= 7ns max., Input Impedance= 1 megohm, 22pF.

2. Rise Time= 10ns max., Source Impedance= 50 ohms.

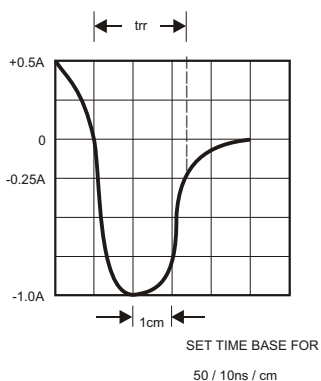


FIG.4-MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT

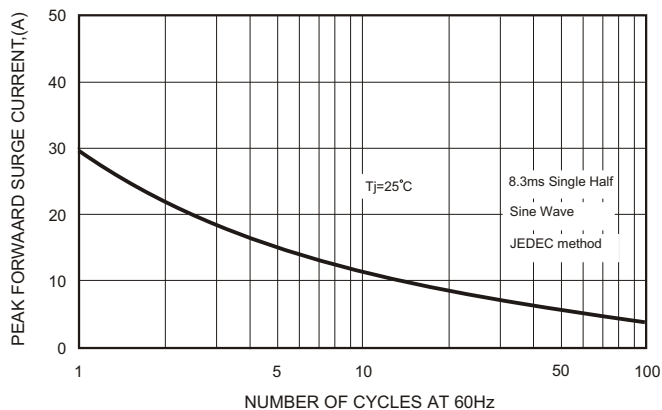
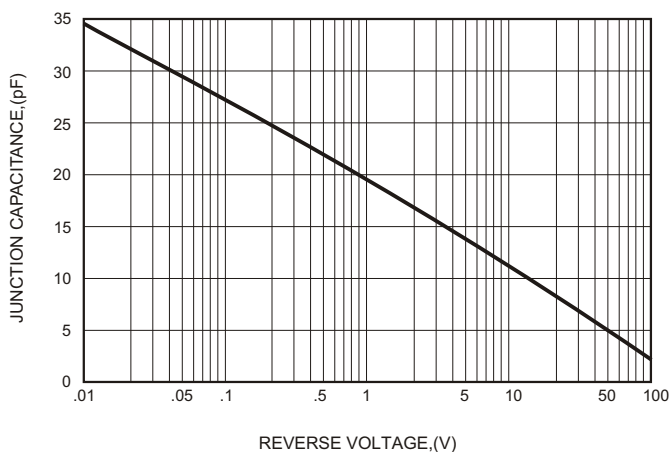
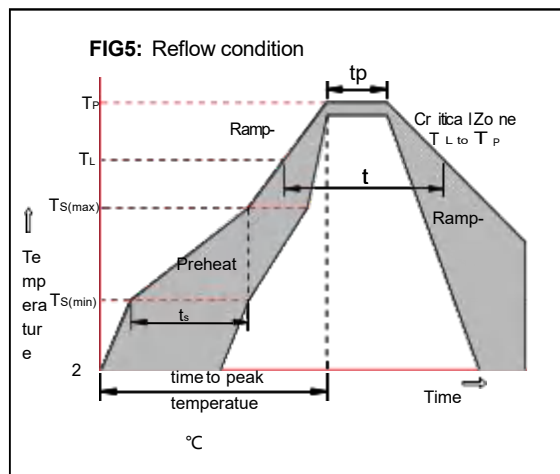


FIG.5-TYPICAL JUNCTION CAPACITANCE



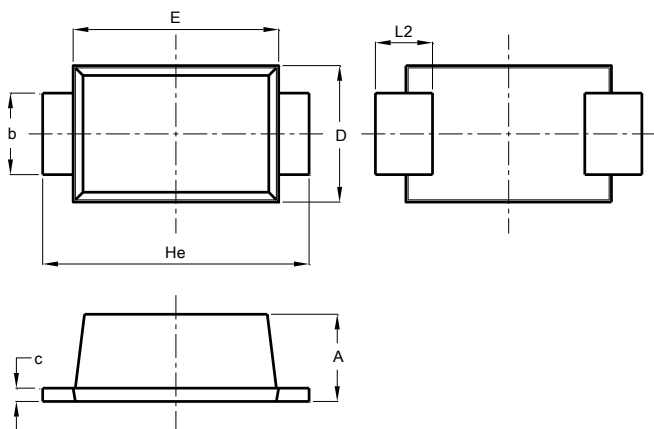
Soldering parameters

Reflow Condition		Pb-Free assembly (see as below)
Pre Heat	-Temperature Min ($T_{s(min)}$)	+150°C
	-Temperature Max($T_{s(max)}$)	+200°C
	-Time (Min to Max) (ts)	60-180 secs.
Average ramp up rate (Liquid us Temp (T_L) to peak)		3°C/sec. Max
$T_{s(max)}$ to T_L - Ramp-up Rate		3°C/sec. Max
Reflow	-Temperature(T_L)(Liquid us)	+217°C
	-Temperature(t_L)	60-150 secs.
Peak Temp (T_P)		+260(+0/-5)°C
Time within 5°C of actual Peak Temp (t_p)		30 secs. Max
Ramp-down Rate		6°C/sec. Max
Time 25°C to Peak Temp (T_P)		8 min. Max
Do not exceed		+260°C

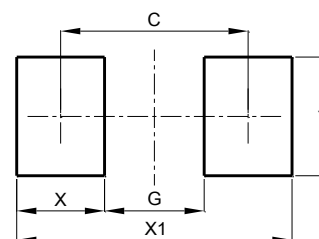


Package Dimensions & Suggested Pad Layout

SOD123FL

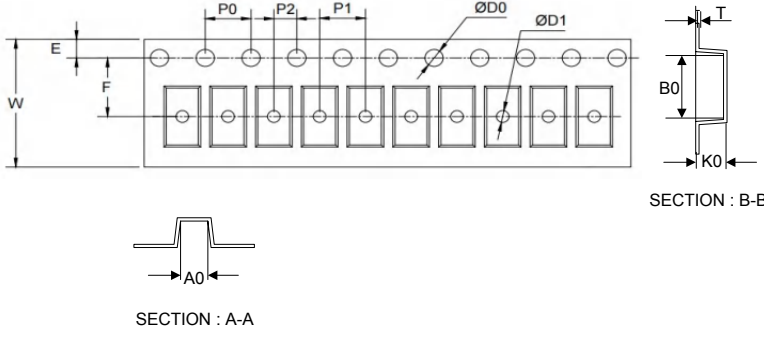
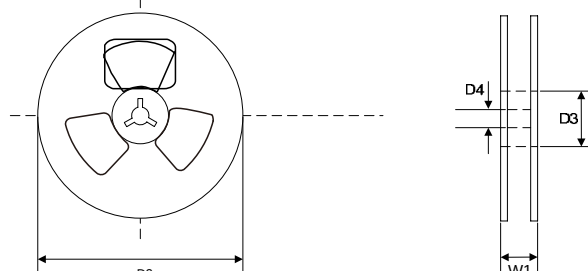


SOD123FL		
Dim	Min	Max
A	1.00	1.20
b	0.80	1.10
c	0.12	0.20
D	1.75	1.95
E	2.60	2.90
He	3.55	3.80
L2	0.50	0.85
All Dimensions in mm		



Dimensions	Value (in mm)
C	3.25
G	2.00
X	1.25
X1	4.50
Y	1.50

Tape & reel specification

Tape		Symbol	Dimension (mm)
		P0	4.00±0.20
		P1	4.00±0.20
		P2	2.00±0.20
		D0	1.55±0.15
		D1	1.00±0.20
		E	1.75±0.20
		F	3.50±0.25
		W	8.00±0.20
		A0	1.85±0.20
		B0	3.95±0.20
		K0	1.30±0.20
		T	0.21±0.10
		D2	178.0±5.0
		D3	55.0Min.
7" Reel		D4	10.0±2.5
		W1	11.5±2.5
		Quantity: 3000PCS	